

Vishay Siliconix

# N-Channel 30-V (D-S) MOSFET

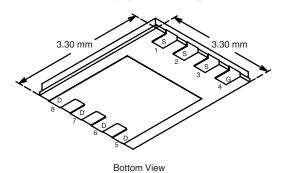
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a, g</sup>	Q <sub>g</sub> (Typ.)			
30	0.0135 at V <sub>GS</sub> = 10 V	16	7.3 nC			
30	$0.0165$ at $V_{GS} = 4.5 \text{ V}$	16	7.3110			

# **FEATURES**

- Halogen-free
- TrenchFET® Gen III Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested



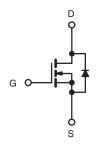
#### PowerPAK® 1212-8



Ordering Information: Si7716ADN-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **APPLICATIONS**

- DC/DC Conversion
  - System Power



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		$V_{GS}$	± 20		
-	T <sub>C</sub> = 25 °C		16 <sup>a, g</sup>		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C		16 <sup>g</sup>		
Continuous Drain Current (1) = 150 °C)	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	12 <sup>b, c</sup>	A	
	T <sub>A</sub> = 70 °C		9.5 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	32 <sup>g</sup>		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	15		
Avalanche Energy	L = 0.111111	E <sub>AS</sub>	11.25	mJ	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		16 <sup>a, g</sup>	A	
	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	2.9 <sup>b, c</sup>	A	
	T <sub>C</sub> = 25 °C		27.7		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	17.7	w	
	T <sub>A</sub> = 25 °C	T D	3.5 <sup>b, c</sup>	VV	
	T <sub>A</sub> = 70 °C		2.2 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	29	36	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	3.6	4.5	] 5/**	

- a. Based on  $T_C$  = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK 1212 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 81 °C/W.
- g. Package limited.

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# Si7716ADN

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			٧	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 uA		33		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 5			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	1.2		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ	
		$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			5		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
Drain-Source On-State Resistance <sup>a</sup>	, ,	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		0.0105	0.0135	Ω	
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 7 \text{ A}$		0.0135	0.0165		
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A		24		S	
Dynamic <sup>b</sup>					•		
Input Capacitance	C <sub>iss</sub>			846		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		187			
Reverse Transfer Capacitance	C <sub>rss</sub>			72			
		V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A		15.4	23	23 11 nC	
Total Gate Charge				7.3	11		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		2.3			
Gate-Drain Charge	$Q_{gd}$			2.2			
Gate Resistance	$R_g$	f = 1 MHz	0.2	0.8	1.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			15	30	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		12	24		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		13	26		
Fall Time	t <sub>f</sub>			10	20		
Turn-On Delay Time	t <sub>d(on)</sub>			9	18		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		9	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		14	28		
Fall Time	t <sub>f</sub>			8	16		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			16	Α	
Pulse Diode Forward Current	I <sub>SM</sub>				32		
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V		0.78	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			17	34	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>.I</sub> = 25 °C		9.5	19	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	i <sub>F</sub> = 10 Λ, αι/αι = 100 Λ/μs, 1 <sub>J</sub> = 25 °C		10			
Reverse Recovery Rise Time	t <sub>b</sub>			7		ns	

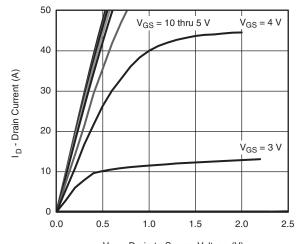
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



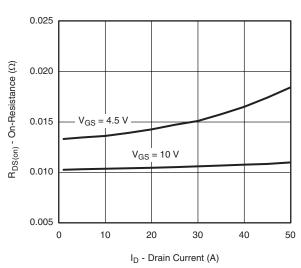
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

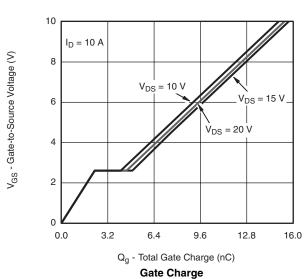


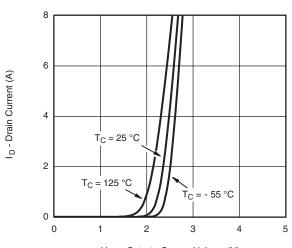
 $V_{\mbox{\scriptsize DS}}$  - Drain-to-Source Voltage (V)

#### **Output Characteristics**



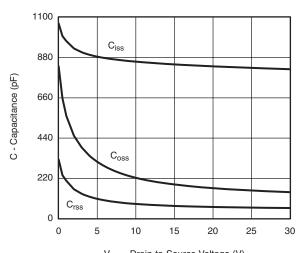
On-Resistance vs. Drain Current and Gate Voltage





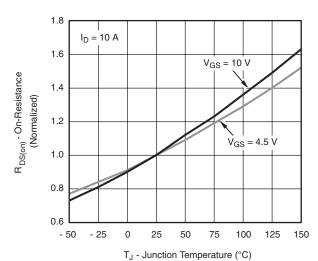
 $V_{\mbox{GS}}$  - Gate-to-Source Voltage (V)

#### **Transfer Characteristics**



V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### Capacitance



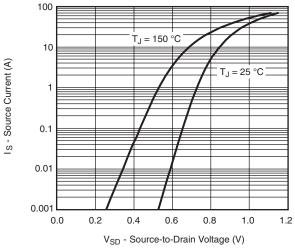
On-Resistance vs. Junction Temperature

# Si7716ADN

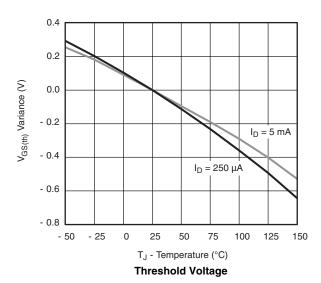
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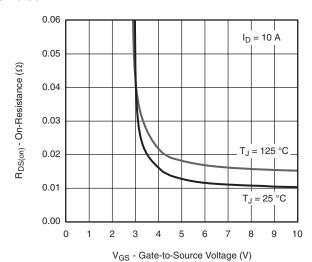
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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

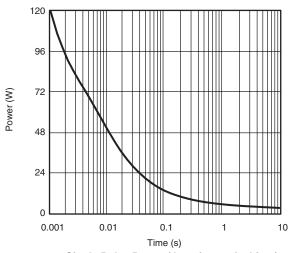


#### Source-Drain Diode Forward Voltage

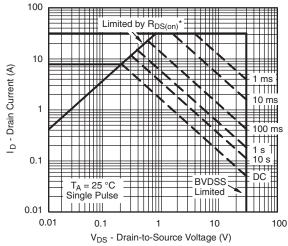




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)



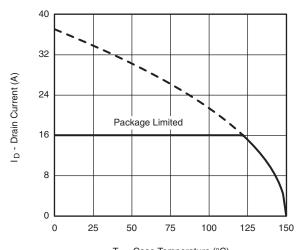
\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

Safe Operating Area, Junction-to-Ambient



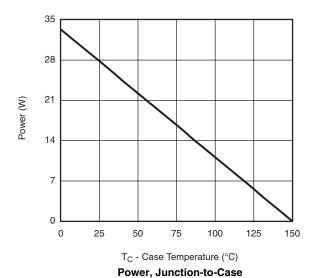
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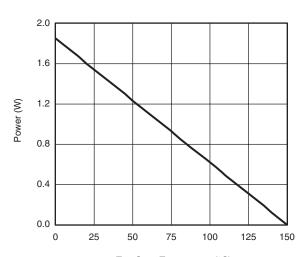
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T<sub>C</sub> - Case Temperature (°C)

#### **Current Derating\***





T<sub>A</sub> - Case Temperature (°C)

Power, Junction-to-Ambient

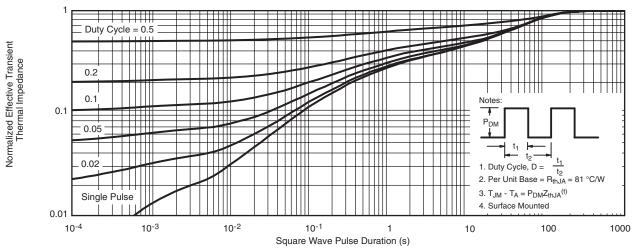
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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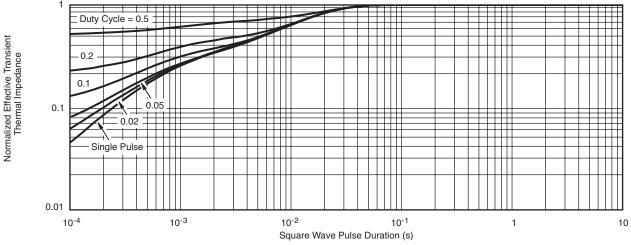
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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